

# **BB184**

# UHF low voltage variable capacitance diode Rev. 3 — 6 September 2011

Product data sheet

#### 1. **Product profile**

### 1.1 General description

The BB184 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD523 (SC-79) ultra small SMD plastic package.

### 1.2 Features and benefits

- Very steep CV curve
- C<sub>d(1V)</sub>: 14 pF; C<sub>d(10V)</sub>: 2 pF
- C<sub>d(1V)</sub> to C<sub>d(10V)</sub> ratio: typical 7
- Ultra small SMD plastic package.

### 1.3 Applications

- Voltage Controlled Oscillators (VCO)
- Tuning in low voltage television.

#### **Pinning information** 2.

Table 1. **Discrete pinning** 

Pin	Description	Simplified outline	Symbol
1	cathode		Ш
2	anode	1 2	+
			sym008

#### **Ordering information** 3.

Table 2. **Ordering information** 

Type number	Package		
	Name	Description	Version
BB184	-	plastic surface mounted package; 2 leads	SOD523

# 4. Marking

Table 3. **Marking** 

Type number	Marking code
BB184	A2



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# 5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_R$	continuous reverse voltage		-	13	V
I <sub>F</sub>	continuous forward current		-	10	mA
T <sub>stg</sub>	storage temperature		<b>–</b> 55	+150	°C
Tj	operating junction temperature		-55	+125	°C

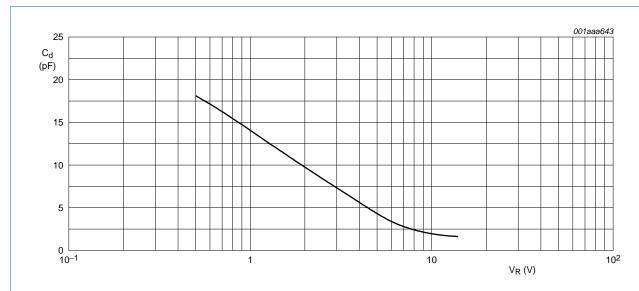
# 6. Characteristics

### Table 5. Electrical characteristics

 $T_i = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$I_R$	reverse current	V <sub>R</sub> = 10 V; see <u>Figure 2</u>	-	-	10	nA
		V <sub>R</sub> = 10 V; T <sub>j</sub> = 85 °C; see <u>Figure 2</u>	-	-	200	nA
r <sub>s</sub>	diode series resistance	$f = 470 \text{ MHz}; C_d = 9 \text{ pF}$	-	0.65	-	Ω
C <sub>d</sub> diode capacitance		f = 1  MHz; see Figure 1 and 3				
		V <sub>R</sub> = 1 V	12.7	14	15.3	pF
		V <sub>R</sub> = 4 V	-	5.5	-	pF
		V <sub>R</sub> = 10 V	1.87	2	2.13	pF
$\frac{C_{d(1V)}}{C_{d(10V)}}$	capacitance ratio	f = 1 MHz	6	7	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	$V_R = 1$ to 10 V; in a sequence of 5 diodes (gliding)	-	-	2	%

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 $f = 1 \text{ MHz}; T_j = 25 \text{ }^{\circ}\text{C}.$ 

Fig 1. Diode capacitance as a function of reverse voltage; typical values.

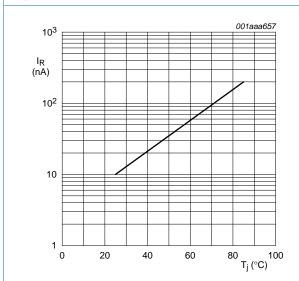


Fig 2. Reverse current as a function of junction temperature; maximum values.

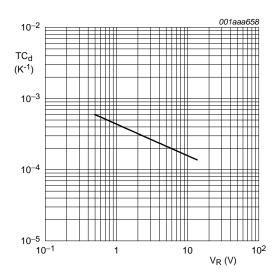


Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

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# 7. Package outline

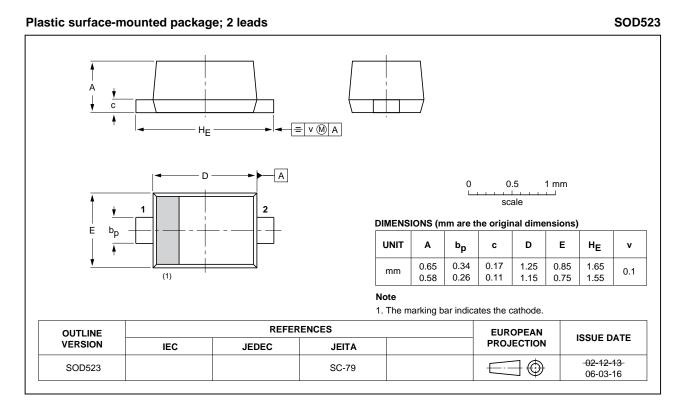


Fig 4. Package outline.

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# 8. Revision history

# Table 6. Revision history

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Document ID	Release date	Data sheet status	Change notice	Supersedes
BB184 v.3	20110906	Product data sheet	-	BB184 v.2
Modifications:	guidelines • Legal texts	of this data sheet has beer of NXP Semiconductors. have been adapted to the i utline drawings have been u	new company name whe	ere appropriate.
BB184 v.2 (9397 750 13004)	20040422	Product data	-	BB184_N v.1
BB184_N v.1 (9397 750 12694)	20040114	Preliminary data	-	-

### UHF low voltage variable capacitance diode

# 9. Legal information

### 9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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